# DATA SHEET



# **PDZ-B series**Voltage regulator diodes

Product data sheet Supersedes data of 2002 Feb 18 2004 Mar 22



# Voltage regulator diodes

# **PDZ-B** series

#### **FEATURES**

- Total power dissipation: max. 400 mW
- Small plastic package suitable for surface mounted design
- Wide variety of voltage ranges: nominal 2.4 to 36 V (E24 range)
- Tolerance approximately ±2%.

#### **APPLICATIONS**

General voltage regulation.

#### DESCRIPTION

Low-power general purpose voltage regulator diodes in a small plastic SMD SOD323 (SC-76) package.

#### PINNING

PIN	DESCRIPTION
1	cathode
2	anode

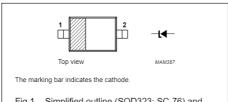


Fig.1 Simplified outline (SOD323; SC-76) and symbol.

#### MARKING

TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE
PDZ2.4B	Z0	PDZ5.1B	Z8	PDZ11B	ZG	PDZ24B	ZQ
PDZ2.7B	Z1	PDZ5.6B	Z9	PDZ12B	ZH	PDZ27B	ZR
PDZ3.0B	Z2	PDZ6.2B	ZA	PDZ13B	ZJ	PDZ30B	ZS
PDZ3.3B	Z3	PDZ6.8B	ZB	PDZ15B	ZK	PDZ33B	ZT
PDZ3.6B	Z4	PDZ7.5B	ZC	PDZ16B	ZL	PDZ36B	ZU
PDZ3.9B	Z5	PDZ8.2B	ZD	PDZ18B	ZM		
PDZ4.3B	Z6	PDZ9.1B	ZE	PDZ20B	ZN		
PDZ4.7B	Z7	PDZ10B	ZF	PDZ22B	ZP		

#### ORDERING INFORMATION

TYPE	PACKAGE						
NUMBER	NAME	DESCRIPTION	VERSION				
PDZ2.4B to PDZ36B	-	plastic surface mounted package; 2 leads	SOD323				

2004 Mar 22 2

# Voltage regulator diodes

PDZ-B series

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
IF	continuous forward current		-	200	mA
I <sub>ZSM</sub>	non-repetitive peak reverse current	t <sub>p</sub> = 100 μs; square wave; T <sub>amb</sub> = 25 °C prior to surge	,	see Table 2	2
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1; see Fig.2	-	400	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

#### Note

1. Device mounted on a printed-circuit board measuring 11  $\times$  25  $\times$  1.6 mm.

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		130	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	340	K/W

#### Note

1. Device mounted on a printed-circuit board measuring 11  $\times$  25  $\times$  1.6 mm.

2004 Mar 22 3

# Voltage regulator diodes

PDZ-B series

# CHARACTERISTICS

**Table 1** Total series T<sub>j</sub> = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 mA; see Fig.3	0.9	V	
		I <sub>F</sub> = 100 mA; see Fig.3	1.1	V	
I <sub>R</sub>	reverse current				
	PDZ2.4B	V <sub>R</sub> = 1 V	50	μА	
	PDZ2.7B	V <sub>R</sub> = 1 V	20	μА	
	PDZ3.0B	V <sub>R</sub> = 1 V	10	μΑ	
	PDZ3.3B	V <sub>R</sub> = 1 V	5	μΑ	
	PDZ3.6B	V <sub>R</sub> = 1 V	5	μΑ	
	PDZ3.9B	V <sub>R</sub> = 1 V	3	μΑ	
	PDZ4.3B	V <sub>R</sub> = 1 V	3	μΑ	
	PDZ4.7B	V <sub>R</sub> = 1 V	2	μΑ	
	PDZ5.1B	V <sub>R</sub> = 1.5 V	2	μΑ	
	PDZ5.6B	V <sub>R</sub> = 2.5 V	1	μА	
	PDZ6.2B	V <sub>R</sub> = 3 V	500	nA	
	PDZ6.8B	V <sub>R</sub> = 3.5 V	500	nA	
	PDZ7.5B	V <sub>R</sub> = 4 V	500	nA	
	PDZ8.2B	V <sub>R</sub> = 5 V	500	nA	
	PDZ9.1B	V <sub>R</sub> = 6 V	500	nA	
	PDZ10B	V <sub>R</sub> = 7 V	100	nA	
	PDZ11B	V <sub>R</sub> = 8 V	100	nA	
	PDZ12B	V <sub>R</sub> = 9 V	100	nA	
	PDZ13B	V <sub>R</sub> = 10 V	100	nA	
	PDZ15B	V <sub>R</sub> = 11 V	50	nA	
	PDZ16B	V <sub>R</sub> = 12 V	50	nA	
	PDZ18B	V <sub>R</sub> = 13 V	50	nA	
	PDZ20B	V <sub>R</sub> = 15 V	50	nA	
	PDZ22B	V <sub>R</sub> = 17 V	50	nA	
	PDZ24B	V <sub>R</sub> = 19 V	50	nA	
	PDZ27B	V <sub>R</sub> = 21 V	50	nA	
	PDZ30B	V <sub>R</sub> = 23 V	50	nA	
	PDZ33B	V <sub>R</sub> = 25 V	50	nA	
	PDZ36B	V <sub>R</sub> = 27 V	50	nA	

2004 Mar 22 4 5

PDZ-B series

TYPE NUMBER	Vz	VOLTAGE (V) : 5 mA	DIFFERENTIAL RESISTANCE $r_{dif}\left(\Omega\right)$		NCE	TEMP. COEFF. S <sub>Z</sub> (mV/K) at I <sub>Z</sub> = 5 mA (see Figs 4 and 5)	DIODE CAP. $C_d$ (pF) at f = 1 MHz; $V_R = 0$	NON-REPETITIVE PEAK REVERSE CURRENT I <sub>ZSM</sub> (A) at t <sub>p</sub> = 100 μs; T <sub>amb</sub> = 25 °C	
	MIN.	MAX.	MAX.	at I <sub>Z</sub> (mA)	MAX.	at I <sub>Z</sub> (mA)	TYP.	MAX.	MAX.
PDZ2.4B	2.43	2.63	1000	0.5	100	5	-1.6	450	8.0
PDZ2.7B	2.69	2.91	1000	0.5	100	5	-2.0	440	8.0
PDZ3.0B	2.85	3.07	1000	0.5	95	5	-2.1	425	8.0
PDZ3.3B	3.32	3.53	1000	0.5	95	5	-2.4	410	8.0
PDZ3.6B	3.60	3.85	500	1.0	90	5	-2.4	390	8.0
PDZ3.9B	3.89	4.16	500	1.0	90	5	-2.5	370	8.0
PDZ4.3B	4.17	4.48	600	1.0	90	5	-2.5	350	8.0
PDZ4.7B	4.55	4.75	600	1.0	90	5	-1.4	325	8.0
PDZ5.1B	4.96	5.20	250	0.5	60	5	0.3	300	5.5
PDZ5.6B	5.48	5.73	100	0.5	50	5	1.9	275	5.5
PDZ6.2B	6.06	6.33	80	0.5	50	5	2.7	250	5.5
PDZ6.8B	6.65	6.93	60	0.5	40	5	3.4	215	5.5
PDZ7.5B	7.28	7.60	60	0.5	10	5	4.0	170	3.5
PDZ8.2B	8.02	8.36	60	0.5	10	5	4.6	150	3.5
PDZ9.1B	8.85	9.23	60	0.5	10	5	5.5	120	3.5
PDZ10B	9.77	10.21	60	0.5	10	5	6.4	110	3.5
PDZ11B	10.78	11.22	60	0.5	10	5	7.4	108	3.0
PDZ12B	11.74	12.24	80	0.5	10	5	8.4	105	3.0
PDZ13B	12.91	13.49	80	0.5	10	5	9.4	103	2.5
PDZ15B	14.34	14.98	80	0.5	15	5	11.4	99	2.0
PDZ16B	15.85	16.51	80	0.5	20	5	12.4	97	1.5
PDZ18B	17.56	18.35	80	0.5	20	5	14.4	93	1.5
PDZ20B	19.52	20.39	100	0.5	20	5	16.4	88	1.5
PDZ22B	21.54	22.47	100	0.5	25	5	18.4	84	1.3
PDZ24B	23.72	24.78	120	0.5	30	5	20.4	80	1.3
PDZ27B	26.19	27.53	150	0.5	40	5	23.4	73	1.0
PDZ30B	29.19	30.69	200	0.5	40	5	26.6	66	1.0
PDZ33B	32.15	33.79	250	0.5	40	5	29.7	60	0.9
PDZ36B	35.07	36.87	300	0.5	60	5	33.0	59	0.8

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# PDZ-B series

## GRAPHICAL DATA

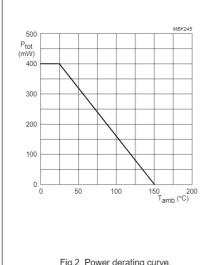
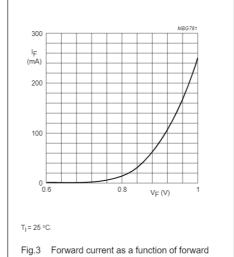
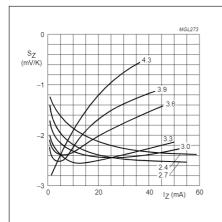


Fig.2 Power derating curve.

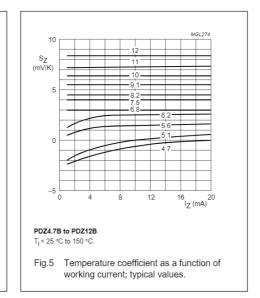


voltage; typical values.



**PDZ2.4B to PDZ4.3B.** T<sub>j</sub> = 25 °C to 150 °C.

Fig.4 Temperature coefficient as a function of working current; typical values.



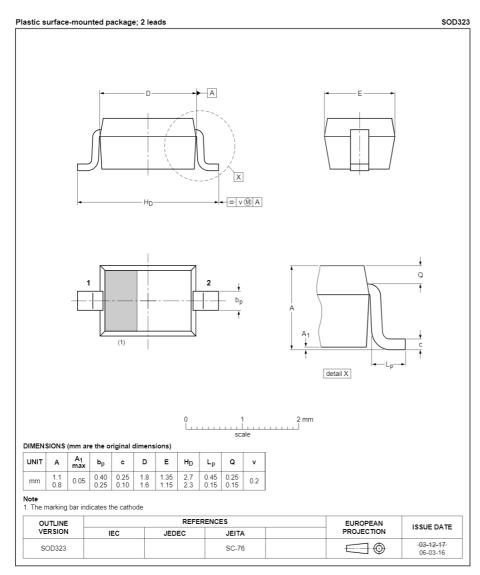
2004 Mar 22

6

# Voltage regulator diodes

# PDZ-B series

## PACKAGE OUTLINE



2004 Mar 22 7

# Voltage regulator diodes

PDZ-B series

#### DATA SHEET STATUS

DOCUMENT STATUS(1)	PRODUCT STATUS(2)	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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2004 Mar 22

8

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#### Contact information

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